

KPT-1608LZGCK-3.0U

1.6 x 0.8 mm SMD Chip LED Lamp

DESCRIPTIONS

- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- . It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- 1.6 mm x 0.8 mm SMD LED, 0.75 mm thickness
- Low power consumption
- · Wide viewing angle
- · Ideal for backlight and indicator
- · Package: 2000 pcs / reel
- · Moisture sensitivity level: 3
- Halogen-free
- · RoHS compliant

APPLICATIONS

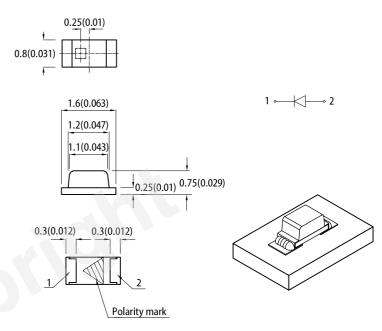
- Backlight
- · Status indicator
- Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

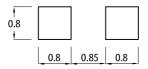


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance: \pm 0.1)



- 1. All dimensions are in millimeters (inches)
- Tolerance is ±0.1(0.004") unless otherwise noted.
 The specifications, characteristics and technical data described in the datasheet are subject to
- change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color	Lens Type	Iv (mcd) @ 2mA [2]		Viewing Angle [1]
rait Nullibei	(Material)	Lens Type	Min.	Тур.	201/2
KPT-1608LZGCK-3.0U	Green (InGaN)	Water Clear	50	100	130°

- Notes.

 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

 2. Luminous intensity / luminous flux: +/-15%.

 3. Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
Parameter			Тур.	Max.	Unit
Wavelength at Peak Emission I _F = 2mA	λ_{peak}	Green	515	-	nm
Dominant Wavelength I _F = 2mA	λ _{dom} ^[1]	Green	525	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 2mA	Δλ	Green	35	-	nm
Capacitance	С	Green	45	-	pF
Forward Voltage I _F = 2mA	V _F ^[2]	Green	2.65	3.0	V
Reverse Current (V _R = 5V)	I _R	Green	-	50	μА
Temperature Coefficient of λ_{peak} I _F = 2mA, -10°C \leq T \leq 85°C	$TC_{\lambda peak}$	Green	0.05	-	nm/°C
Temperature Coefficient of λ_{dom} $I_F = 2mA$, $-10^{\circ}C \le T \le 85^{\circ}C$	TC_{\lambdadom}	Green	0.03	-	nm/°C
Temperature Coefficient of V_F I_F = 2mA, -10° C \leq T \leq 85° C	TC _V	Green	-2.9	-	mV/°C

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	P _D	102.5	mW
Reverse Voltage	V_R	5	V
Junction Temperature	T _j	115	°C
Operating Temperature	T _{op}	-40 to +85	°C
Storage Temperature	T _{stg}	-40 to +85	°C
DC Forward Current	I _F	25	mA
Peak Forward Current	I _{FM} ^[1]	150	mA
Electrostatic Discharge Threshold (HBM)	-	450	V
Thermal Resistance (Junction / Ambient)	R _{th JA} [2]	570	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} [2]	380	°C/W

Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. R_{th. JA}, R_{th. JS} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad).

3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

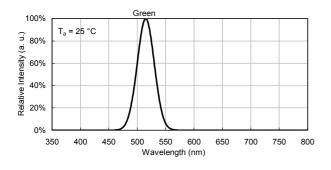


^{1.} The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd:±1nm.)
2. Forward voltage: ±0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

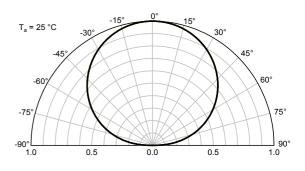


TECHNICAL DATA

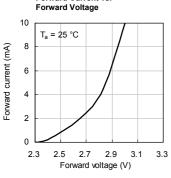
RELATIVE INTENSITY vs. WAVELENGTH

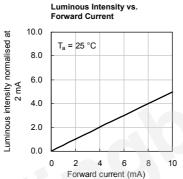


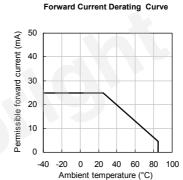
SPATIAL DISTRIBUTION

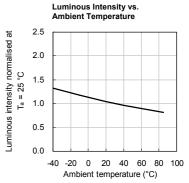




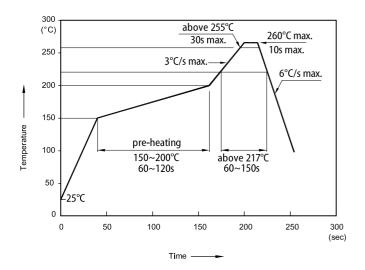








REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



Notes:

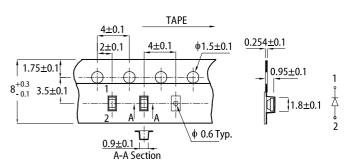
- Notes:

 1. Don't cause stress to the LEDs while it is exposed to high temperature.

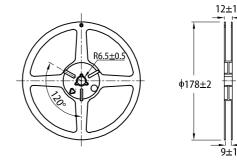
 2. The maximum number of reflow soldering passes is 2 times.

 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

TAPE SPECIFICATIONS (units: mm)



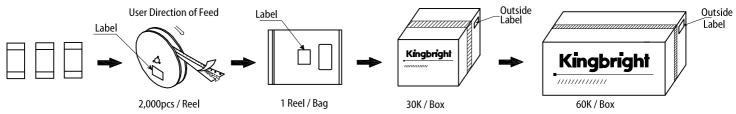
REEL DIMENSION (units:mm)



φ60±2



PACKING & LABEL SPECIFICATIONS





PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer
- to the latest datasheet for the updated specifications.

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